

N-Channel Super Junction Power MOSFET II

General Description

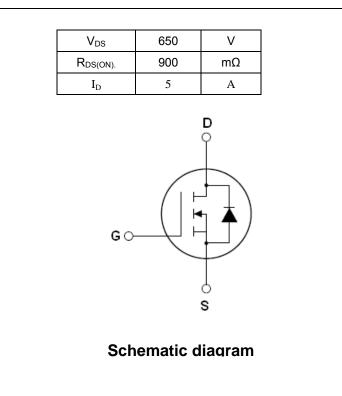
The series of devices use advanced super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- •New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

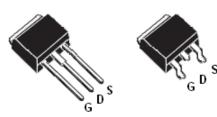
Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)



Package Marking And Ordering Information

Device	Device Package	Marking
NCE65R900I	TO-251	NCE65R900I
NCE65R900K	TO-252	NCE65R900K



TO-251

TO-252

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGs=0V)	Vds	650	V
Gate-Source Voltage (VDs=0V)	Vgs	±30	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	5	А
Continuous Drain Current at Tc=100°C	I _{D (DC)}	3	А
Pulsed drain current (Note 1)	DM (pluse)	15	А
Drain Source voltage slope, VDS = 480 V, ID = 5 A, Tj = 125 °C	dv/dt	48	V/ns
Maximum Power Dissipation(Tc=25°C)	PD	49	W
Derate above 25°C		0.39	W/°C
Single pulse avalanche energy (Note2)	Eas	135	mJ
Avalanche current ^(Note 1)	I _{AR}	2.5	А



Parameter	Symbol	Value	Unit
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.4	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	2.55	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	75	°C /W

Table 3. Electrical Characteristics (TA=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	650			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2.5	3	3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.5A		780	900	mΩ
Dynamic Characteristics						
Forward Transconductance	g fs	V _{DS} = 20V, I _D = 3A		4.8		S
Input Capacitance	Clss			460		pF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V, F=1.0MHz		45		pF
Reverse Transfer Capacitance	C _{rss}			3.5		pF
Total Gate Charge	Qg)/ _480)// _54		10	20	nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =5A, V _{GS} =10V		1.6		nC
Gate-Drain Charge	Q _{gd}	VGS-10V		4		nC
Intrinsic gate resistance	R_{G}	f = 1 MHz open drain		2.5		Ω
Switching times						
Turn-on Delay Time	t _{d(on)}			6		nS
Turn-on Rise Time	tr	V _{DD} =380V,I _D =3A,		3		nS
Turn-Off Delay Time	t _{d(off)}	R _G =18Ω,V _{GS} =10V		50	60	nS
Turn-Off Fall Time	t _f			9	15	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T -05°0			5	А
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			15	А
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =5A,V _{GS} =0V		1	1.3	V
Reverse Recovery Time	t _{rr}			250		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =5A,di/dt=100A/µs		2.2		uC
Peak reverse recovery current	Irrm			15		А

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^\circ C$,VDD=50V,VG=10V, R_G=25\Omega



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

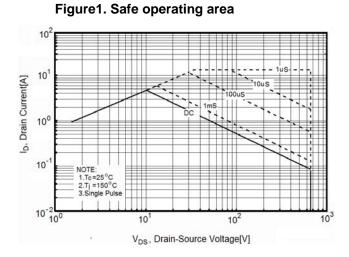


Figure3. Output characteristics

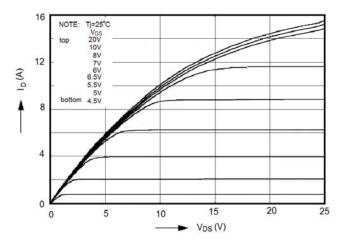


Figure5. Static drain-source on resistance

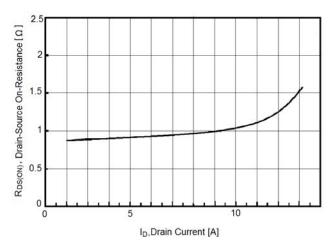


Figure2. Source-Drain Diode Forward Voltage

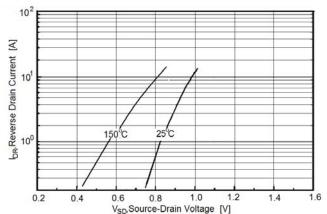


Figure4. Transfer characteristics

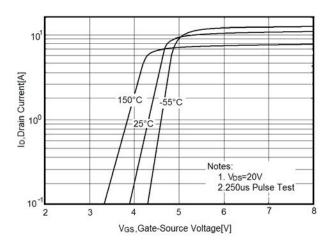


Figure6. R_{DS(ON)} vs Junction Temperature

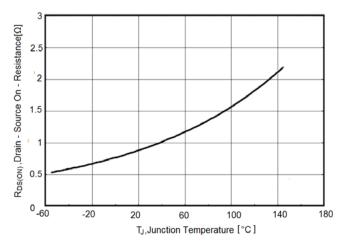




Figure7. BV_{DSS} vs Junction Temperature

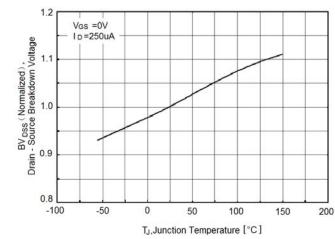


Figure9. Gate charge waveforms

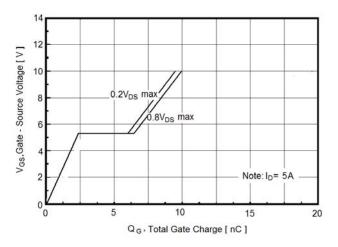


Figure11. Transient Thermal Impedance

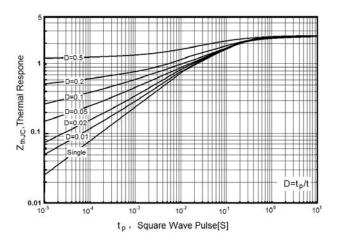


Figure8. Maximum $I_{\mbox{\scriptsize D}}$ vs Junction Temperature

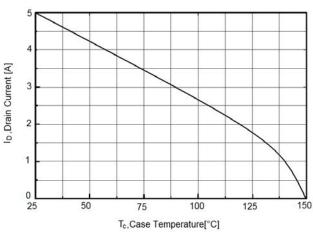
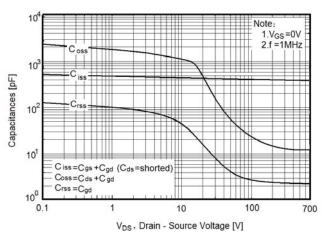


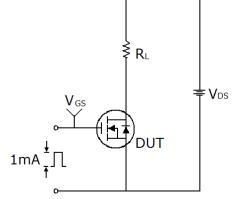
Figure10. Capacitance



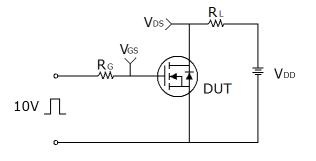


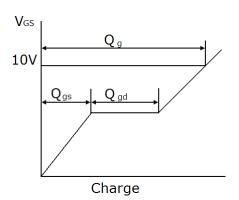
Test circuit

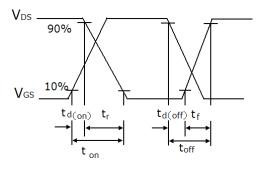
1) Gate charge test circuit & Waveform



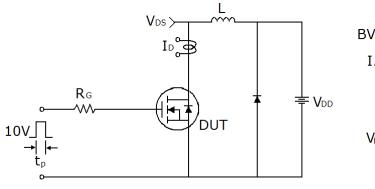
2) Switch Time Test Circuit:

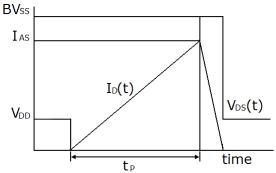






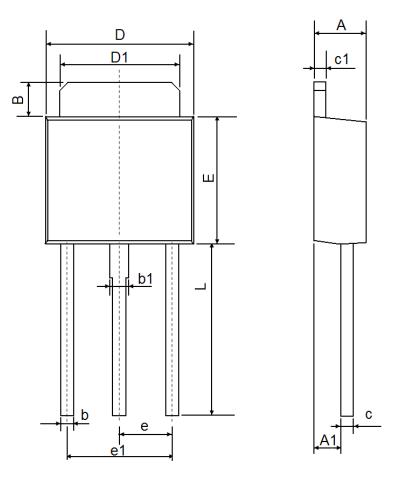
3) Unclamped Inductive Switching Test Circuit & Waveforms







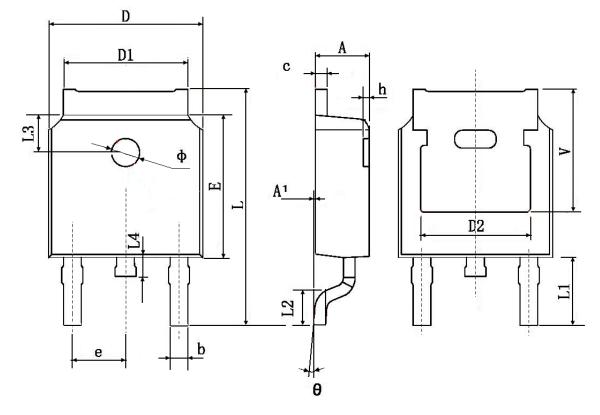
TO-251 Package Information



Sumbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
с	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.09	1 TYP	
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	



TO-252 Package Information



Sumbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483	B TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900) TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600) TYP.	0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211 TYP.		



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